

<IGBT Modules>

# CM400DY-34T

HIGH POWER SWITCHING USE  
INSULATED TYPE



dual switch (half-bridge)

Collector current  $I_C$  ..... **400 A**  
 Collector-emitter voltage  $V_{CES}$  ..... **1700 V**  
 Maximum junction temperature  $T_{vjmax}$  ..... **175 °C**

- Flat base type
- Nickel-plating tab terminals
- RoHS Directive compliant
- UL Recognized under UL1557, File No.E323585

## APPLICATION

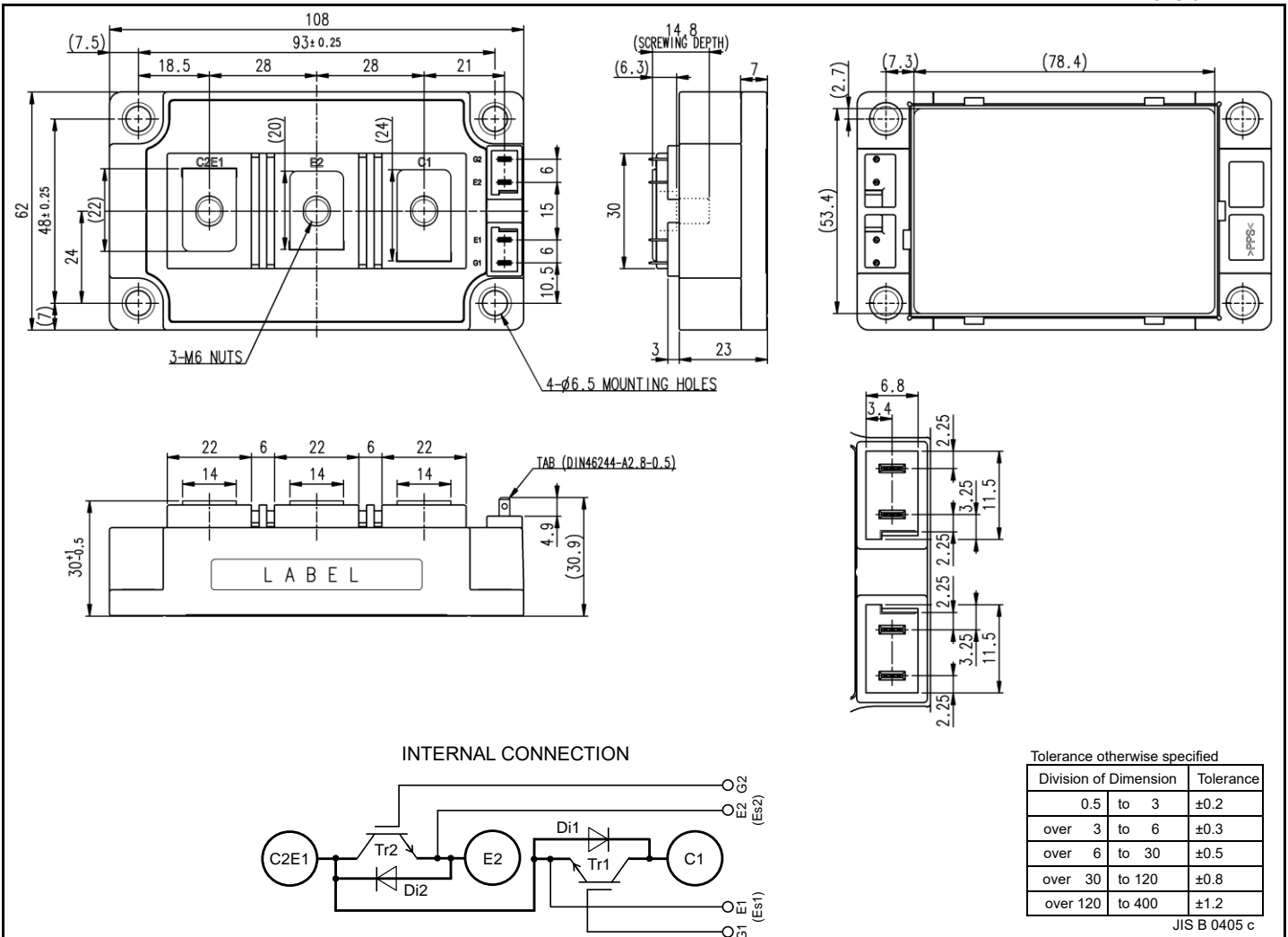
AC Motor Control, Motion/Servo Control, Power supply, etc.

## OPTION (Below options are available.)

- PC-TIM (Phase Change Thermal Interface Material) pre-apply (Note8)
- $V_{CESat}$  selection for parallel connection

## OUTLINE DRAWING & INTERNAL CONNECTION

Dimension in mm



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MAXIMUM RATINGS (T<sub>vj</sub>=25 °C, unless otherwise specified)

Symbol	Item	Conditions	Rating	Unit
V <sub>CES</sub>	Collector-emitter voltage	G-E short-circuited	1700	V
V <sub>GES</sub>	Gate-emitter voltage	C-E short-circuited	± 20	V
I <sub>C</sub>	Collector current	DC, T <sub>C</sub> =132 °C* (Note2, 4)	400	A
I <sub>CRM</sub>		Pulse, Repetitive (Note3)	800	
P <sub>tot</sub>	Total power dissipation	T <sub>C</sub> =25 °C (Note2, 4)	4345	W
I <sub>E</sub> (Note1)	Emitter current	DC (Note2)	400	A
I <sub>ERM</sub> (Note1)		Pulse, Repetitive (Note3)	800	
V <sub>isol</sub>	Isolation voltage	Terminals to base plate, RMS, f=60 Hz, AC 1 min	4000	V
T <sub>vjmax</sub>	Maximum junction temperature	Instantaneous event (overload) (Note8)	175	°C
T <sub>Cmax</sub>	Maximum case temperature	(Note4,8)	150*	
T <sub>vjop</sub>	Operating junction temperature	Continuous operation (under switching) (Note8)	-40 ~ +150	°C
T <sub>stg</sub>	Storage temperature	-	-40 ~ +150*	

ELECTRICAL CHARACTERISTICS (T<sub>vj</sub>=25 °C, unless otherwise specified)

Symbol	Item	Conditions		Limits			Unit
				Min.	Typ.	Max.	
I <sub>CES</sub>	Collector-emitter cut-off current	V <sub>CE</sub> =V <sub>CES</sub> , G-E short-circuited		-	-	1.0	mA
I <sub>GES</sub>	Gate-emitter leakage current	V <sub>GE</sub> =V <sub>GES</sub> , C-E short-circuited		-	-	0.5	μA
V <sub>GE(th)</sub>	Gate-emitter threshold voltage	I <sub>C</sub> =40 mA, V <sub>CE</sub> =10 V		5.4	6.0	6.6	V
V <sub>CESat</sub> (Terminal)	Collector-emitter saturation voltage	I <sub>C</sub> =400 A, V <sub>GE</sub> =15 V, Refer to the figure of test circuit (Note5)	T <sub>vj</sub> =25 °C	-	2.10	2.50	V
			T <sub>vj</sub> =125 °C	-	2.55	-	
			T <sub>vj</sub> =150 °C	-	2.65	-	
V <sub>CESat</sub> (Chip)		I <sub>C</sub> =400 A, V <sub>GE</sub> =15 V, (Note5)	T <sub>vj</sub> =25 °C	-	1.95	2.35	V
			T <sub>vj</sub> =125 °C	-	2.35	-	
			T <sub>vj</sub> =150 °C	-	2.45	-	
C <sub>ies</sub>	Input capacitance	V <sub>CE</sub> =10 V, G-E short-circuited		-	-	110	nF
C <sub>oes</sub>	Output capacitance			-	-	2.9	
C <sub>res</sub>	Reverse transfer capacitance			-	-	0.9	
Q <sub>G</sub>	Gate charge	V <sub>CC</sub> =1000 V, I <sub>C</sub> =400 A, V <sub>GE</sub> =15 V		-	3.1	-	μC
t <sub>d(on)</sub>	Turn-on delay time	V <sub>CC</sub> =1000 V, I <sub>C</sub> =400 A, V <sub>GE</sub> =±15 V, R <sub>G</sub> =0 Ω, Inductive load		-	-	800	ns
t <sub>r</sub>	Rise time			-	-	200	
t <sub>d(off)</sub>	Turn-off delay time			-	-	800	
t <sub>f</sub>	Fall time			-	-	600	
V <sub>EC</sub> (Note.1) (Terminal)	Emitter-collector voltage	I <sub>E</sub> =400 A, G-E short-circuited, Refer to the figure of test circuit (Note5)	T <sub>vj</sub> =25 °C	-	2.80	3.55	V
			T <sub>vj</sub> =125 °C	-	3.05	-	
			T <sub>vj</sub> =150 °C	-	3.05	-	
V <sub>EC</sub> (Note.1) (Chip)		I <sub>E</sub> =400 A, G-E short-circuited, (Note5)	T <sub>vj</sub> =25 °C	-	2.65	3.35	V
			T <sub>vj</sub> =125 °C	-	2.75	-	
			T <sub>vj</sub> =150 °C	-	2.75	-	
t <sub>rr</sub> (Note1)	Reverse recovery time	V <sub>CC</sub> =1000 V, I <sub>E</sub> =400 A, V <sub>GE</sub> =±15 V, R <sub>G</sub> =0 Ω, Inductive load		-	-	300	ns
Q <sub>rr</sub> (Note1)	Reverse recovery charge	R <sub>G</sub> =0 Ω, Inductive load		-	20	-	μC
E <sub>on</sub>	Turn-on switching energy per pulse	V <sub>CC</sub> =1000 V, I <sub>C</sub> =I <sub>E</sub> =400 A, V <sub>GE</sub> =±15 V, R <sub>G</sub> =0 Ω, T <sub>vj</sub> =150 °C, Inductive load		-	80.6	-	mJ
E <sub>off</sub>	Turn-off switching energy per pulse			-	97.5	-	
E <sub>rr</sub> (Note1)	Reverse recovery energy per pulse	Inductive load		-	50.6	-	mJ
R <sub>CC'+EE'</sub>	Internal lead resistance	Main terminals-chip, per switch, T <sub>C</sub> =25 °C (Note4)		-	0.3	-	mΩ
r <sub>g</sub>	Internal gate resistance	Per switch		-	2.0	-	Ω

\*The value of PC-TIM applied module is limited by the heat resistant temperature of PC-TIM.

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**THERMAL RESISTANCE CHARACTERISTICS**

Symbol	Item	Conditions	Limits			Unit
			Min.	Typ.	Max.	
$R_{th(j-c)Q}$	Thermal resistance	Junction to case, per Inverter IGBT (Note4)	-	-	34.5	K/kW
$R_{th(j-c)D}$		Junction to case, per Inverter FWD (Note4)	-	-	58.3	
$R_{th(c-s)}$	Contact thermal resistance	Case to heat sink, per 1 module Thermal grease applied (Note4,6,8)	-	13.3	-	K/kW

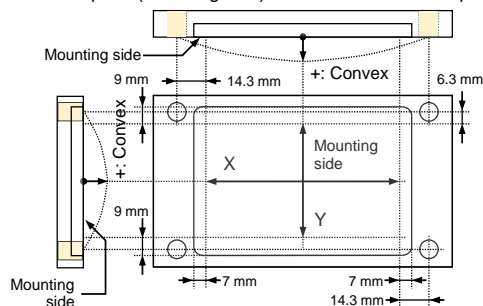
**MECHANICAL CHARACTERISTICS**

Symbol	Item	Conditions	Limits			Unit
			Min.	Typ.	Max.	
$M_t$	Mounting torque	Main terminals M 6 screw	3.5	4.0	4.5	N·m
$M_s$	Mounting torque	Mounting to heat sink M 6 screw	3.5	4.0	4.5	N·m
$d_s$	Creepage distance	Terminal to terminal	17.3	-	-	mm
		Terminal to base plate	25.3	-	-	
$d_a$	Clearance	Terminal to terminal	12.6	-	-	mm
		Terminal to base plate	21.8	-	-	
$e_c$	Flatness of base plate	On the centerline X, Y (Note7)	±0	-	+200	μm
m	mass	-	-	260	-	g

\*, This product is compliant with the Restriction of the Use of Certain Hazardous Substances in Electrical and Electronic Equipment (RoHS) directive 2011/65/EU and (EU) 2015/863.

Note1. Represent ratings and characteristics of the anti-parallel, emitter-collector free-wheeling diode (FWD).

- Junction temperature ( $T_{vj}$ ) should not increase beyond  $T_{vjmax}$  rating.
- Pulse width and repetition rate should be such that the device junction temperature ( $T_{vj}$ ) does not exceed  $T_{vjmax}$  rating.
- Case temperature ( $T_c$ ) and heat sink temperature ( $T_s$ ) are defined on the each surface (mounting side) of base plate and heat sink just under the chips. Refer to the figure of chip location.
- Pulse width and repetition rate should be such as to cause negligible temperature rise. Refer to the figure of test circuit.
- Typical value is measured by using thermally conductive grease of  $\lambda=3.0 \text{ W/(m}\cdot\text{K)}/D_{(C-S)}=50 \text{ }\mu\text{m}$ .
- The base plate (mounting side) flatness measurement points (X, Y) are shown in the following figure.



- Long term performance related to thermal conductive grease and PC-TIM (including but not limited to aspects such as the increase of thermal resistance due to pumping out, etc.) should be verified under your specific application conditions. Each temperature condition ( $T_{vjmax}$ ,  $T_{vjop}$ ,  $T_{cmax}$ ) must be maintained below the maximum rated temperature throughout consideration of the temperature rise even for long term usage.

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HIGH POWER SWITCHING USE

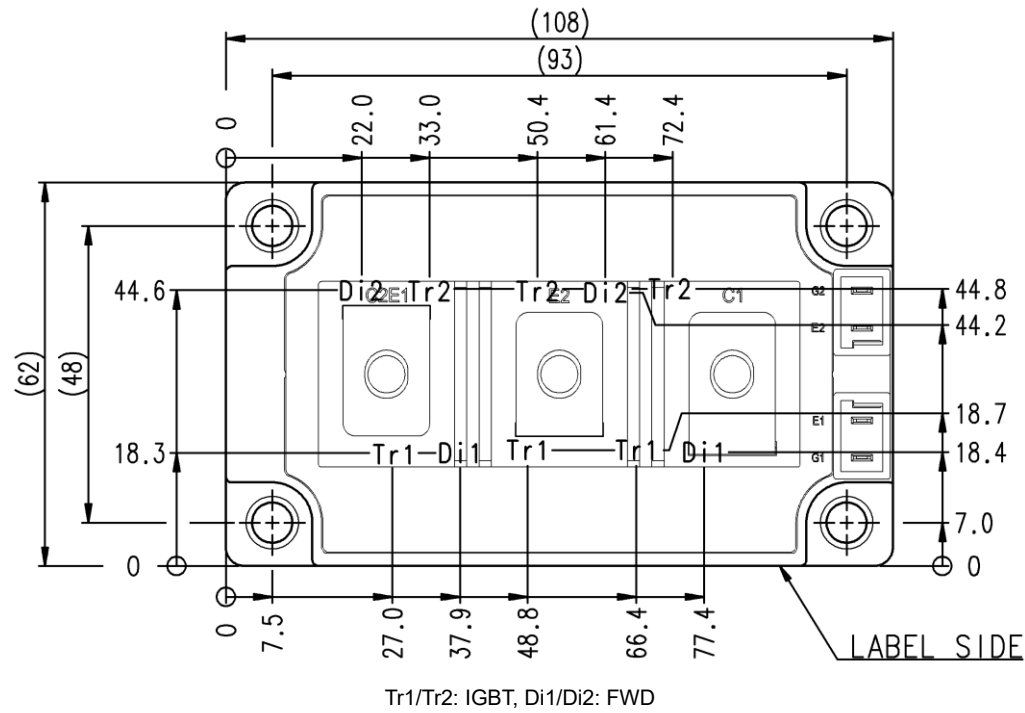
INSULATED TYPE

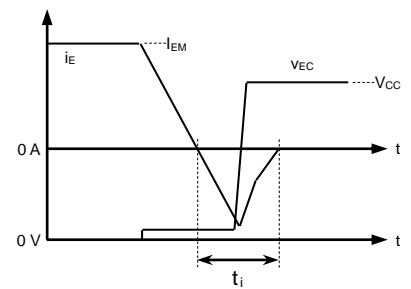
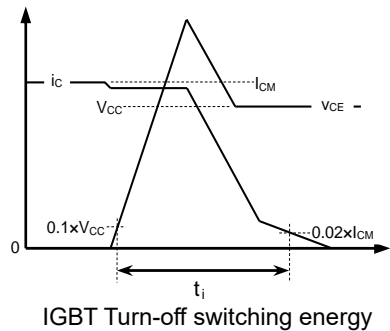
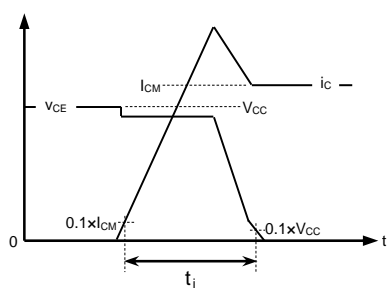
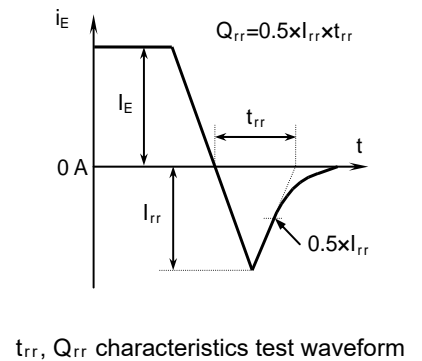
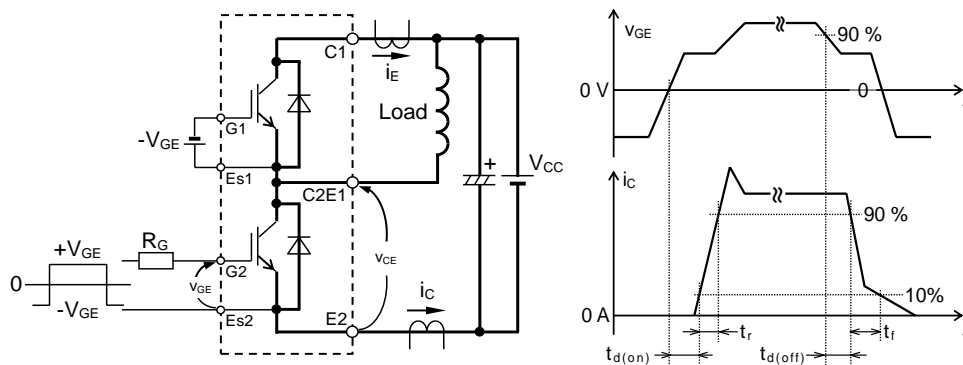
RECMENDED OPERATING CONDITIONS

Symbol	Item	Conditions	Limits			Unit
			Min.	Typ.	Max.	
$V_{CC}$	(DC) Supply voltage	Applied across C1-E2 terminals	-	1000	1200	V
$V_{GEon}$	Gate (-emitter drive) voltage	Applied across G1-Es1/G2-Es2 terminals	13.5	15.0	16.5	V
$R_G$	External gate resistance	Per switch	0	-	30	$\Omega$

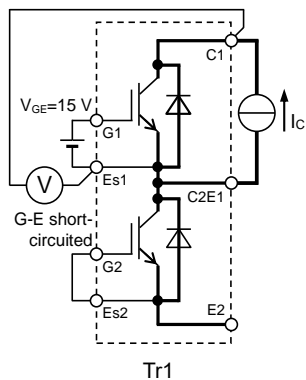
CHIP LOCATION (Top view)

Dimension in mm, tolerance:  $\pm 1$  mm

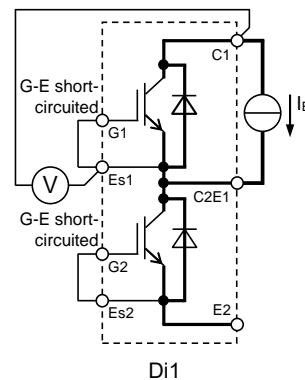
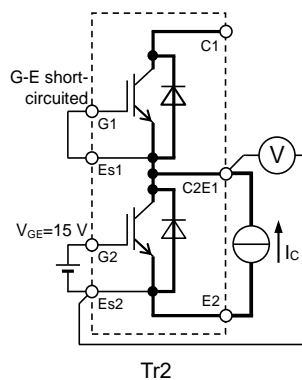


**TEST CIRCUIT AND WAVEFORMS**

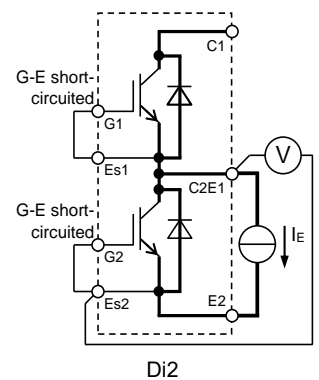
Turn-on / Turn-off switching energy and Reverse recovery energy test waveforms (Integral time instruction drawing)

**TEST CIRCUIT**

$V_{CEsat}$  characteristics test circuit



$V_{EC}$  characteristics test circuit

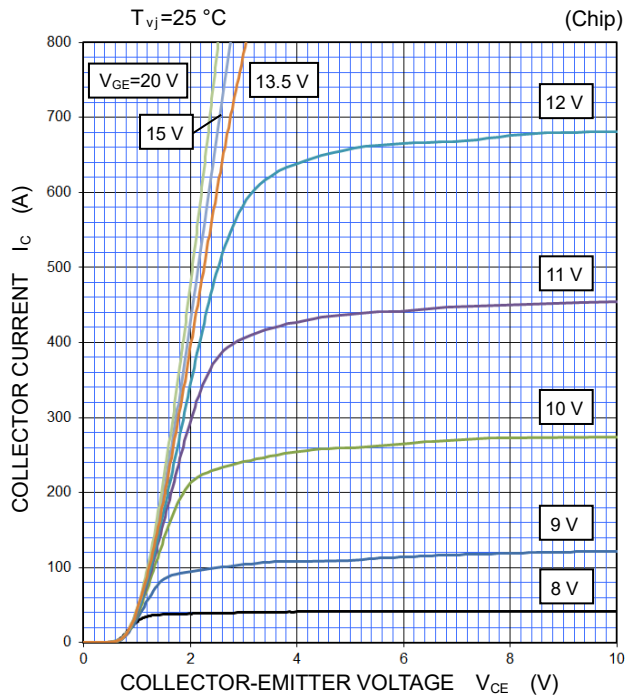


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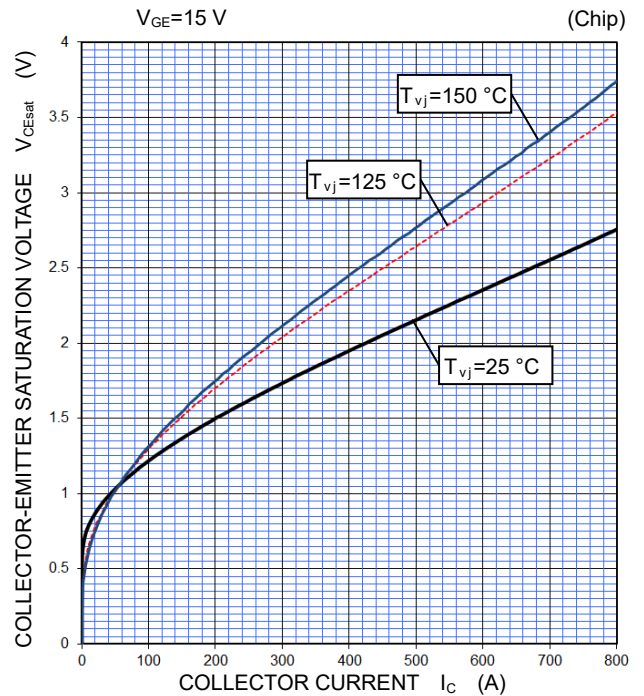
HIGH POWER SWITCHING USE  
INSULATED TYPE

**PERFORMANCE CURVES**

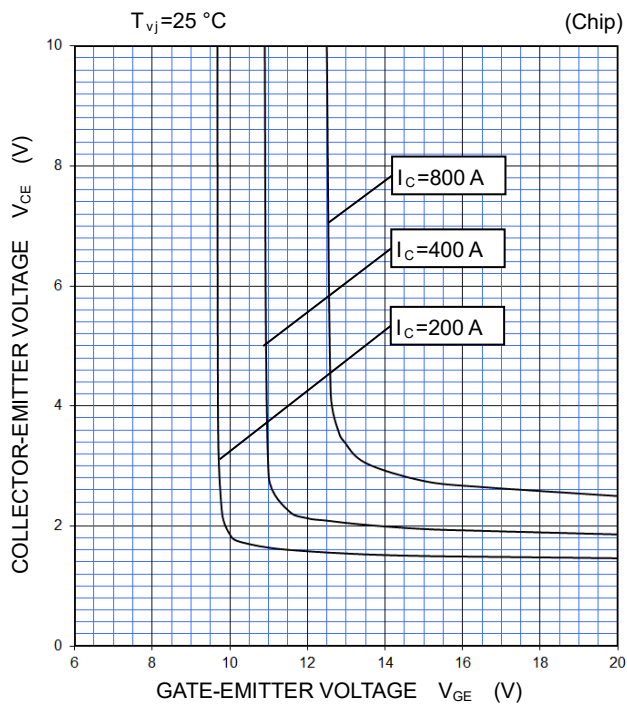
**OUTPUT CHARACTERISTICS  
(TYPICAL)**



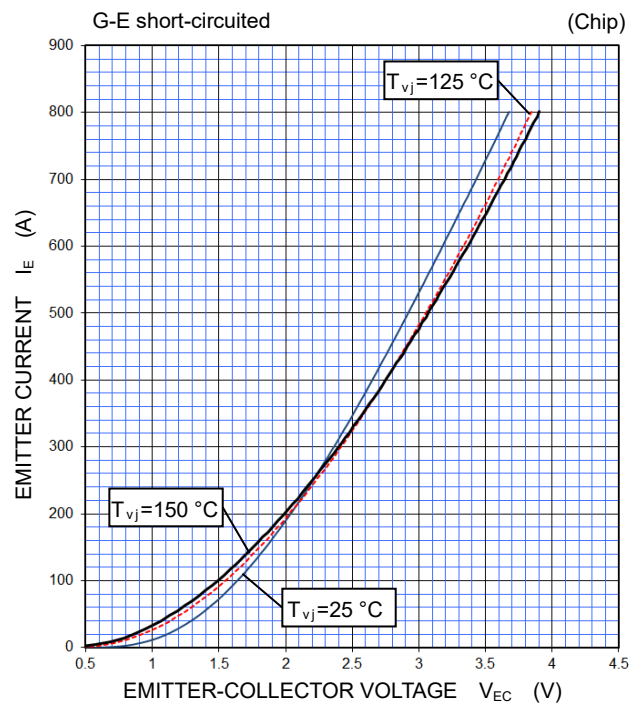
**COLLECTOR-EMITTER SATURATION VOLTAGE  
CHARACTERISTICS  
(TYPICAL)**



**COLLECTOR-EMITTER VOLTAGE CHARACTERISTICS  
(TYPICAL)**



**FREE WHEELING DIODE  
FORWARD CHARACTERISTICS  
(TYPICAL)**



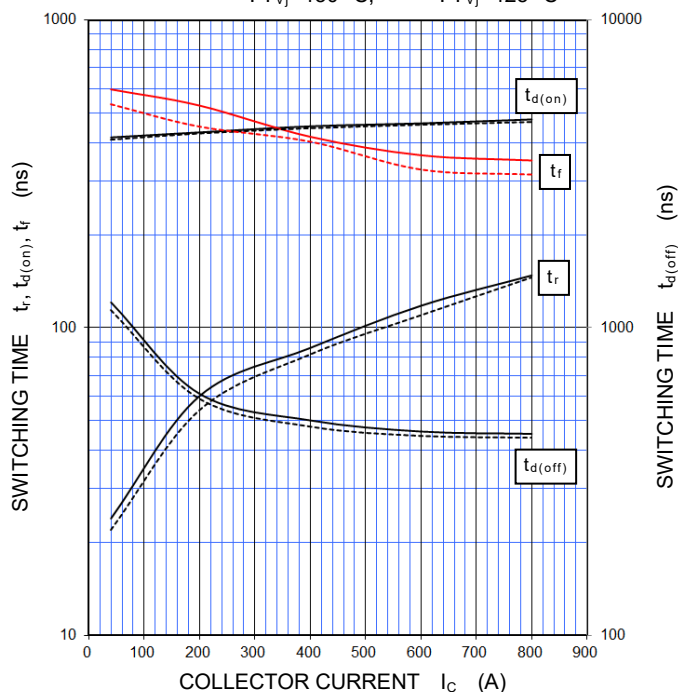
**CM400DY-34T**

HIGH POWER SWITCHING USE  
INSULATED TYPE

**PERFORMANCE CURVES**

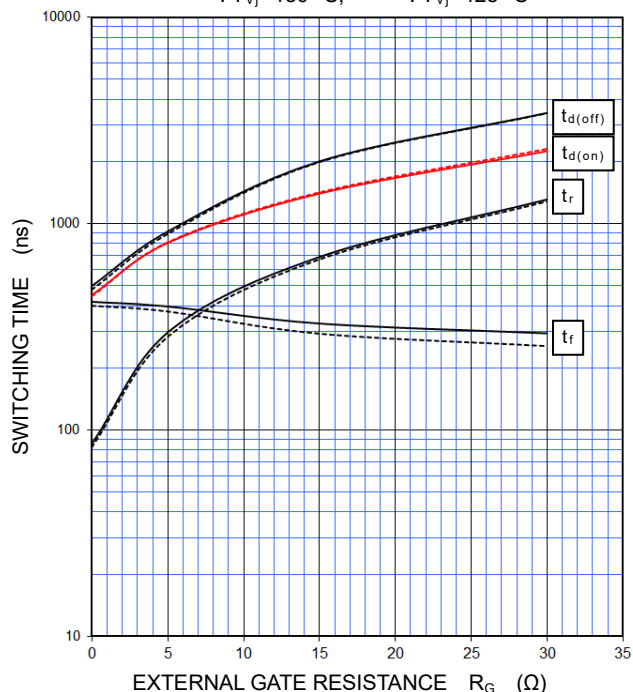
**HALF-BRIDGE SWITCHING CHARACTERISTICS  
(TYPICAL)**

$V_{CC}=1000\text{ V}$ ,  $V_{GE}=\pm 15\text{ V}$ ,  $R_G=0\ \Omega$ , INDUCTIVE LOAD  
—:  $T_{vj}=150\text{ }^\circ\text{C}$ , - - - -:  $T_{vj}=125\text{ }^\circ\text{C}$



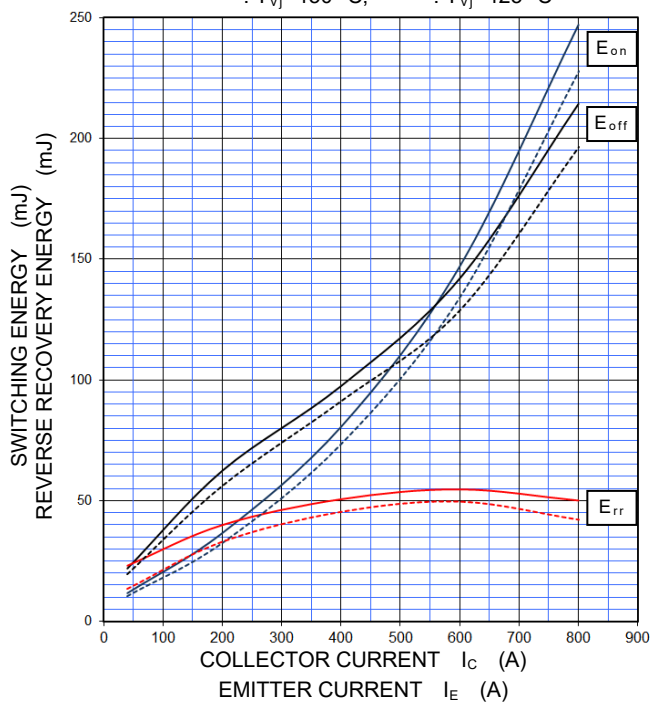
**HALF-BRIDGE SWITCHING CHARACTERISTICS  
(TYPICAL)**

$V_{CC}=1000\text{ V}$ ,  $V_{GE}=\pm 15\text{ V}$ ,  $I_C=400\text{ A}$ , INDUCTIVE LOAD  
—:  $T_{vj}=150\text{ }^\circ\text{C}$ , - - - -:  $T_{vj}=125\text{ }^\circ\text{C}$



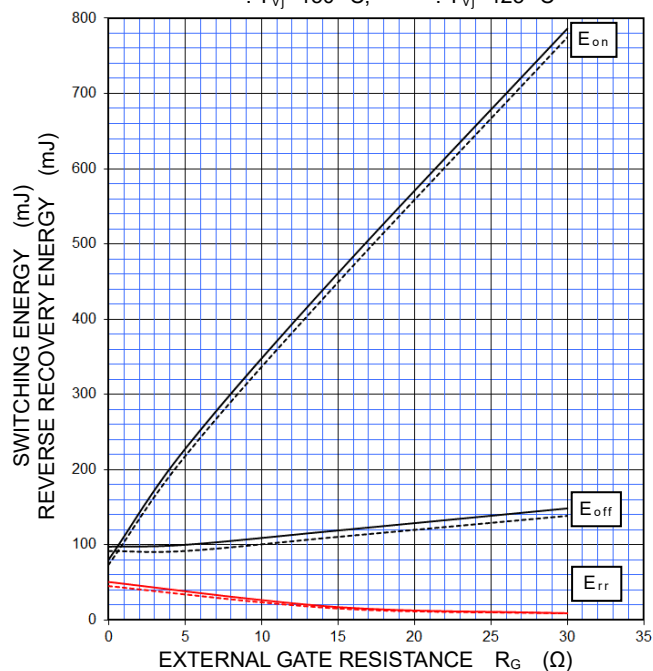
**HALF-BRIDGE SWITCHING CHARACTERISTICS  
(TYPICAL)**

$V_{CC}=1000\text{ V}$ ,  $V_{GE}=\pm 15\text{ V}$ ,  $R_G=0\ \Omega$ , INDUCTIVE LOAD  
—:  $T_{vj}=150\text{ }^\circ\text{C}$ , - - - -:  $T_{vj}=125\text{ }^\circ\text{C}$



**HALF-BRIDGE SWITCHING CHARACTERISTICS  
(TYPICAL)**

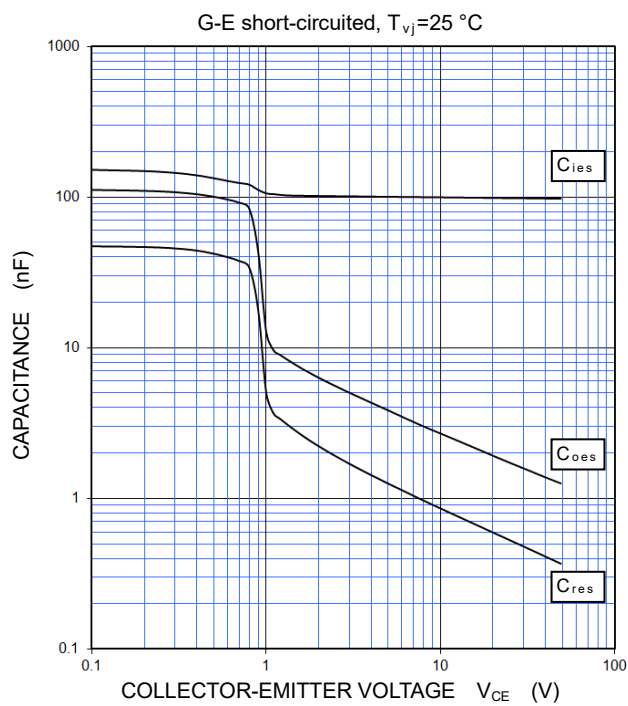
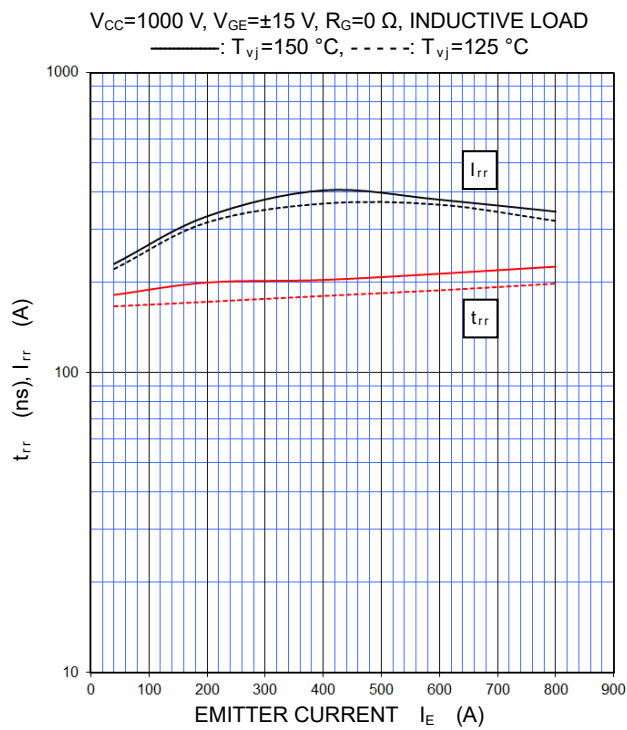
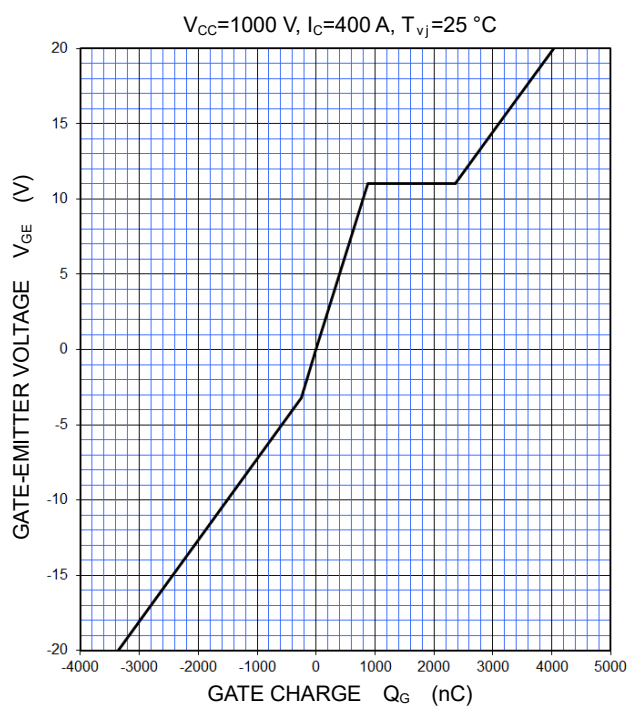
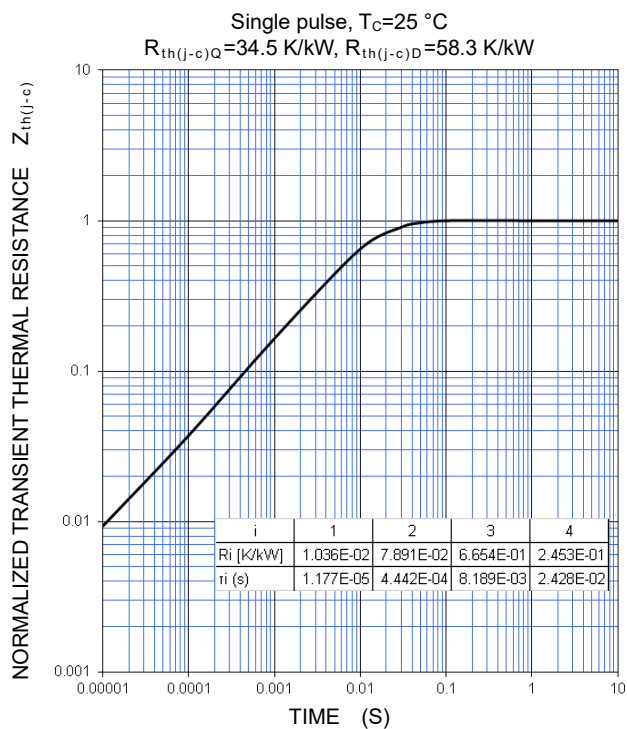
$V_{CC}=1000\text{ V}$ ,  $V_{GE}=\pm 15\text{ V}$ ,  $I_C=400\text{ A}$ , INDUCTIVE LOAD  
—:  $T_{vj}=150\text{ }^\circ\text{C}$ , - - - -:  $T_{vj}=125\text{ }^\circ\text{C}$



**CM400DY-34T**

HIGH POWER SWITCHING USE

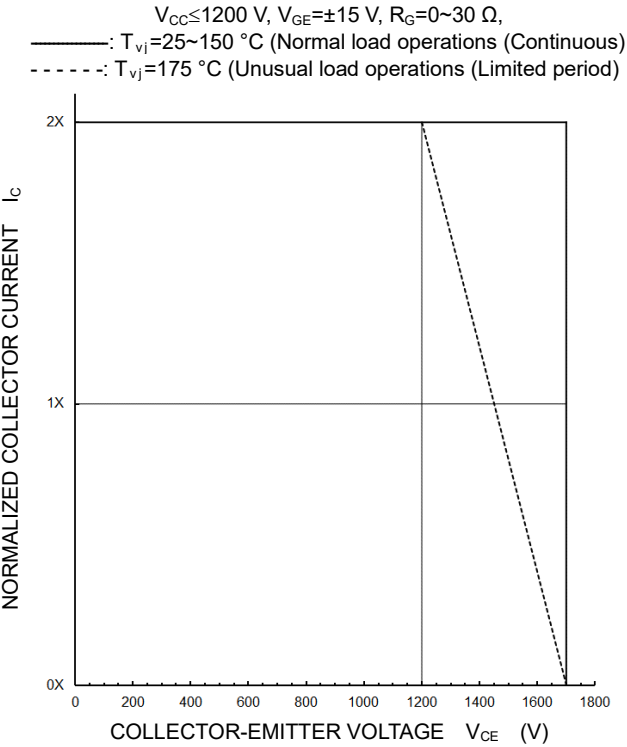
INSULATED TYPE

**PERFORMANCE CURVES****CAPACITANCE CHARACTERISTICS  
(TYPICAL)****FREE WHEELING DIODE  
REVERSE RECOVERY CHARACTERISTICS  
(TYPICAL)****GATE CHARGE CHARACTERISTICS  
(TYPICAL)****TRANSIENT THERMAL IMPEDANCE CHARACTERISTICS  
(MAXIMUM)**

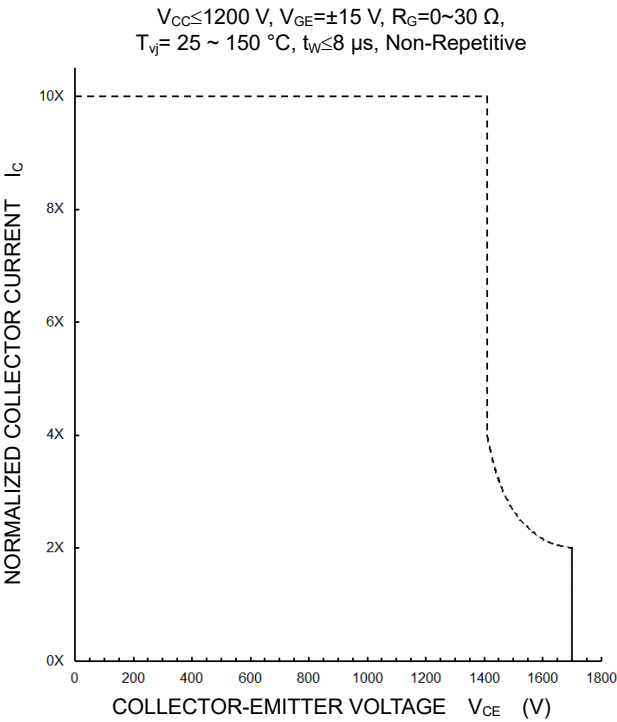


PERFORMANCE CURVES

TURN-OFF SWITCHING SAFE OPERATING AREA  
(REVERSE BIAS SAFE OPERATING AREA)  
(MAXIMUM)



SHORT-CIRCUIT SAFE OPERATING AREA  
(MAXIMUM)



Note: The characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

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